LTCC SURFACE MOUNT

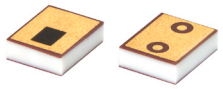
Low Pass Filter

LFHK-2250+

50Ω DC to 2250 MHz

THE BIG DEAL

- Low Insertion Loss, 1.5 dB Typ.
- Passband Return Loss, 18 dB Typ.
- Stopband Rejection, 72 dB Typ.
- 1008 Surface Mount Footprint
- Power Handling: 7.5 W

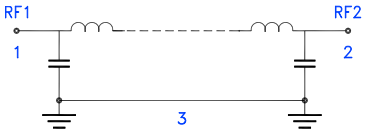


Generic photo used for illustration purposes only

APPLICATIONS

- Test and Measurement Equipment
- Harmonic Rejection
- VHF/UHF Transmitters / Receivers
- Lab use

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

Mini-Circuits' LFHK-2250+ is a miniature low temperature co-fired ceramic (LTCC) low pass filter with a DC to 2250 MHz passband supporting a variety of applications. This model provides 1.5 dB typical insertion loss over a wide band due to its rugged monolithic construction. Housed in a small 1008 ceramic form factor the filter is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well suited for environmental extremes of high humidity and temperature.

KEY FEATURES

Features	Advantages
Ultra-Wide Stopband	The LTCC lowpass filter provides a very good stopband rejection up to 43 GHz, suitable for wide band applications.
LTCC Construction	Provides repeatable performance in a rugged, ceramic package well suited for tough environments such as high humidity and temperature extremes.
Small Size, 1008	Saves space in dense circuit board layouts and minimizes the effects of parasitics.
Rugged Power Handling,7.5 Watts	Handles up to 7.5 Watts in a small 1008 package.

Low Pass Filter

LFHK-2250+

50Ω DC to 2250 MHz

ELECTRICAL SPECIFICATIONS[1,2,3] AT +25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Insertion Loss	DC-F1	DC - 2250	—	1.5	2.3	dB
	Freq. Cut-Off[4]	Fc	2530	—	3	—	dB
	Return Loss	DC-F1	DC - 2250	10	18	—	dB
Stopband	Rejection	F2-F3	3100 - 4800	20	34	—	dB
		F3-F4	4800 - 11000	65	72	—	
		F4-F5	11000 - 18000	50	68	—	
		F5-F6	18000 - 35000	38	45	—	
		F6-F7	35000 - 43000	27	46	—	

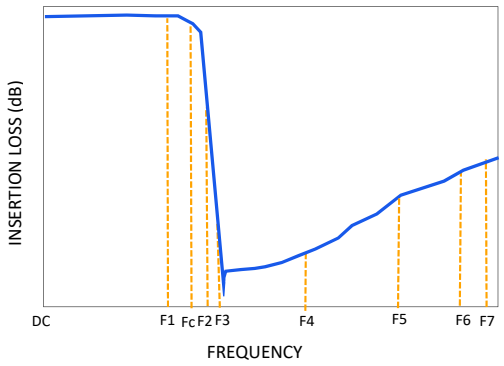
1. Tested on Evaluation Board P/N TB-LFHK-2250+ with connectors and feedline de-embedded with thru-line compensation.
2. This filter is bi-directional, RF1 and RF2 ports may be interchanged.
3. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
4. Typical variation ±5%.

ABSOLUTE MAXIMUM RATINGS[5]

Parameter	Ratings
Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
Input Power[6]	7.5 W @ +25°C

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 1.3 W at +125°C.

TYPICAL FREQUENCY RESPONSE AT +25°C



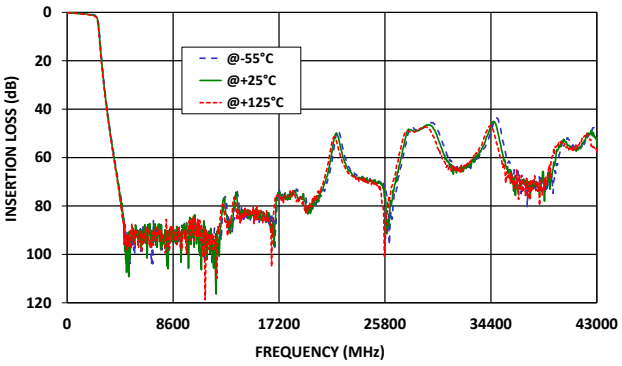
Low Pass Filter

LFHK-2250+

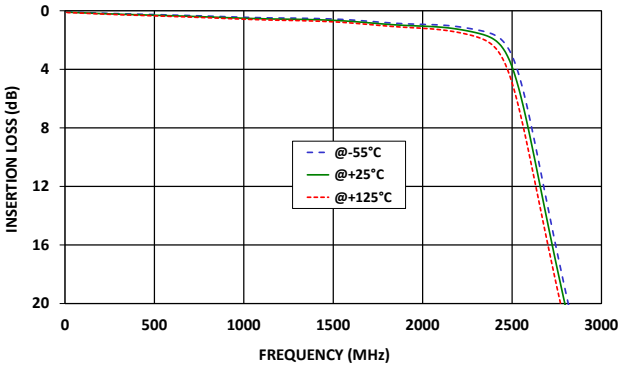
50Ω DC to 2250 MHz

TYPICAL PERFORMANCE GRAPHS

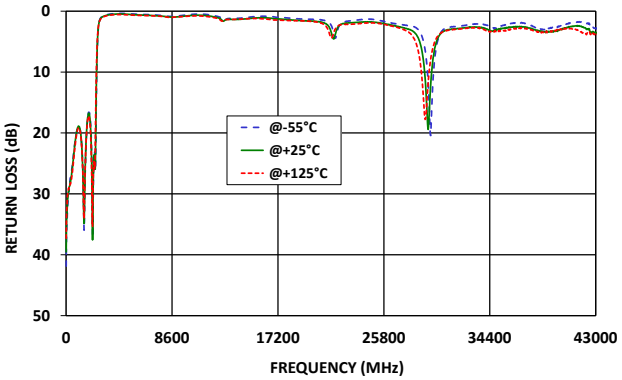
LFHK-2250+
INSERTION LOSS



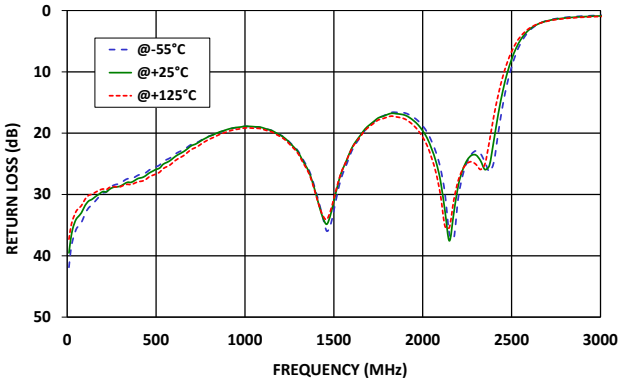
LFHK-2250+
INSERTION LOSS (Zoomed)



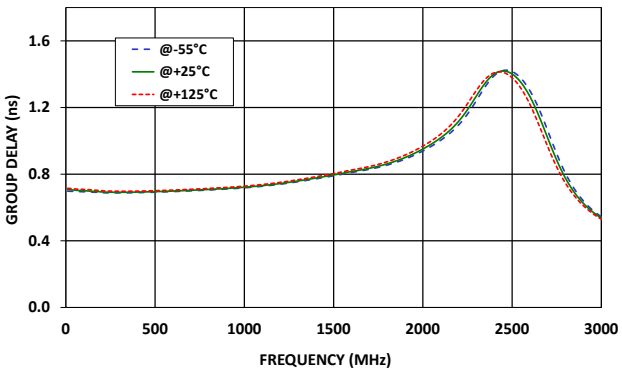
LFHK-2250+
RETURN LOSS



LFHK-2250+
RETURN LOSS (Zoomed)



LFHK-2250+
GROUP DELAY



LTCC SURFACE MOUNT

Low Pass Filter

LFHK-2250+

50Ω DC to 2250 MHz

FUNCTIONAL DIAGRAM

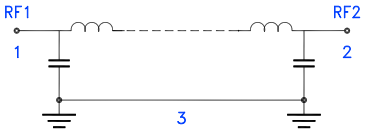
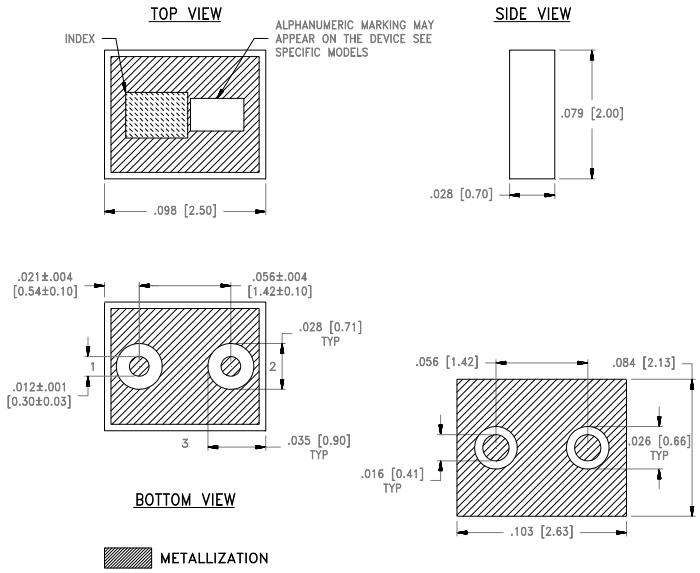


Figure 1. LFHK-2250+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1[2]	1	Connects to RF Input Port
RF2[2]	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-798)
NC	-	No connection, not used internally. See drawing PL-798 for connection to PCB

CASE STYLE DRAWING



Weight: .019 grams.
Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

PRODUCT MARKING*: ZV

*Marking may contain other features or characters for internal lot control.

Low Pass Filter

LFHK-2250+

50Ω DC to 2250 MHz

SUGGESTED PCB LAYOUT (PL-798)

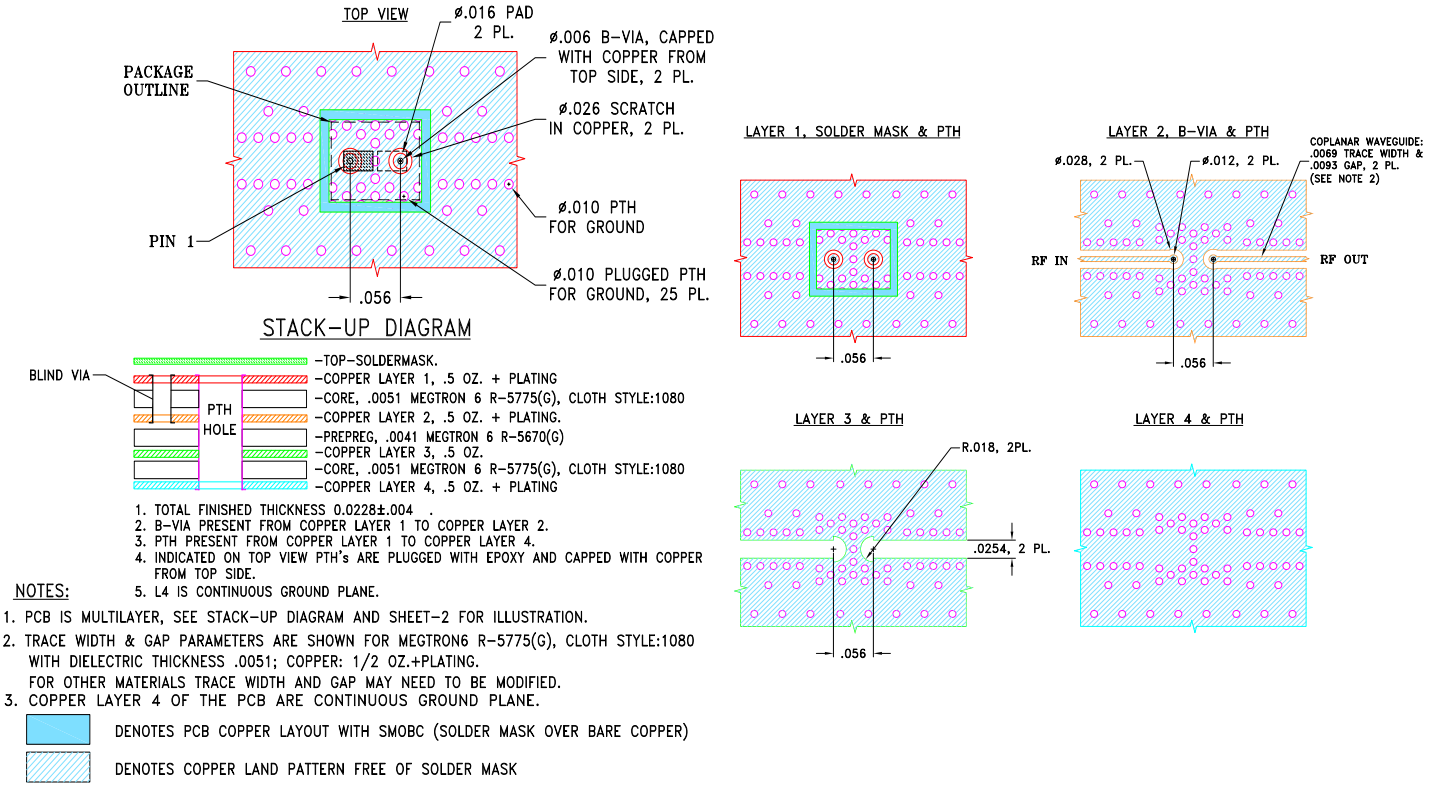


Figure 2. Suggested PCB Layout PL-798

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Low Pass Filter

LFHK-2250+

50Ω DC to 2250 MHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD. CLICK HERE

Performance Data and Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	NL1008C-9 Lead Finish: Gold over Electroless Nickel
RoHS Status	Compliant
Tape and Reel	TR-F75
Suggested Layout for PCB Design	PL-798
Evaluation Board	TB-LFHK-2250+
	Gerber File
Environmental Rating	ENV06T10

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Ceramic Low Pass Filter LFHK-2250+

Typical Performance Data

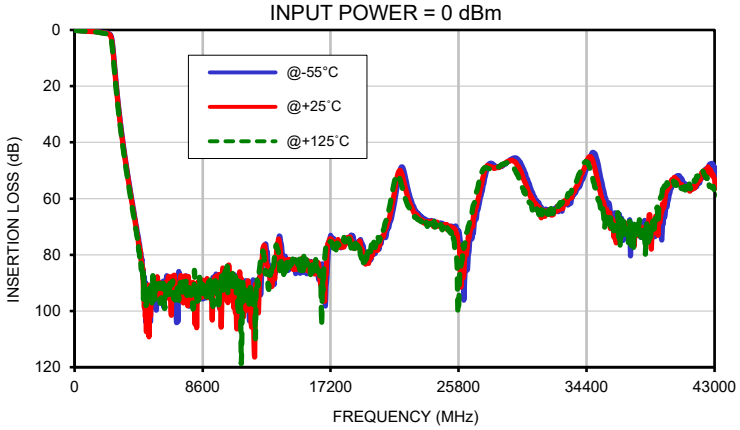
FREQ.	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
(MHz)	(dB)			(dB)			(dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
10	0.07	0.09	0.11	41.87	39.53	37.29	41.40	38.93	36.90
50	0.10	0.12	0.14	35.71	34.05	32.76	35.78	34.07	32.79
100	0.12	0.14	0.17	33.20	31.83	30.80	33.21	31.85	30.85
200	0.16	0.19	0.22	29.77	29.53	29.11	29.64	29.47	29.11
500	0.26	0.31	0.35	25.47	25.91	26.66	25.49	25.88	26.54
1000	0.44	0.51	0.58	18.90	18.87	19.15	19.00	19.02	19.36
1500	0.57	0.66	0.76	32.60	31.09	30.67	34.87	33.25	32.85
2000	0.93	1.05	1.20	18.82	19.63	20.67	18.76	19.62	20.82
2250	1.18	1.37	1.61	24.70	24.39	24.92	24.77	24.57	25.34
2530	4.07	4.99	6.26	6.69	5.88	5.07	6.76	5.95	5.16
3100	33.78	34.66	35.76	0.70	0.79	0.87	0.69	0.78	0.90
4000	65.12	66.09	67.28	0.39	0.49	0.58	0.40	0.49	0.59
4800	104.16	98.20	98.08	0.38	0.49	0.59	0.40	0.50	0.59
5000	92.49	109.19	92.28	0.40	0.51	0.60	0.42	0.52	0.61
5500	99.64	95.04	93.22	0.47	0.58	0.66	0.46	0.57	0.67
6000	98.72	97.05	93.55	0.52	0.63	0.70	0.51	0.63	0.73
6500	94.43	101.55	90.26	0.55	0.67	0.73	0.56	0.69	0.79
7000	85.93	94.80	96.23	0.60	0.72	0.77	0.61	0.74	0.84
7500	87.61	94.62	89.32	0.66	0.77	0.82	0.65	0.78	0.89
8000	93.20	94.46	98.61	0.77	0.86	0.92	0.67	0.80	0.91
8500	92.79	92.98	88.77	0.86	0.96	1.02	0.68	0.81	0.91
9000	94.40	90.32	89.60	0.79	0.93	0.95	0.67	0.80	0.90
9500	86.84	87.60	92.14	0.68	0.83	0.88	0.63	0.77	0.87
10000	91.64	85.22	86.36	0.57	0.74	0.82	0.60	0.75	0.86
10500	89.70	95.71	89.40	0.49	0.67	0.77	0.60	0.77	0.89
11000	97.50	91.74	99.84	0.48	0.67	0.79	0.61	0.80	0.93
11500	89.18	91.15	97.87	0.57	0.77	0.90	0.67	0.86	1.00
12000	88.93	94.27	97.73	0.73	0.93	1.06	0.76	0.96	1.11
12500	94.29	86.72	81.18	0.99	1.22	1.42	0.87	1.11	1.30
13000	85.61	85.60	91.57	1.32	1.38	1.37	1.02	1.18	1.27
13500	86.36	80.77	77.50	1.20	1.36	1.36	0.96	1.17	1.27
14000	82.18	81.43	83.07	1.18	1.36	1.34	0.97	1.20	1.29
14500	82.98	81.96	83.09	1.07	1.27	1.26	0.97	1.21	1.32
15000	83.92	82.58	83.46	0.95	1.16	1.20	0.94	1.21	1.33
15500	84.15	83.87	85.63	0.87	1.10	1.21	0.94	1.21	1.36
16000	85.83	83.25	85.09	0.84	1.09	1.26	0.94	1.22	1.41
17000	82.49	76.41	75.88	0.98	1.26	1.45	1.29	1.52	1.58
18000	76.00	77.23	75.70	1.11	1.39	1.52	1.02	1.30	1.46
19000	76.31	76.75	76.60	1.28	1.55	1.59	1.14	1.43	1.59
20000	79.38	80.12	78.52	1.32	1.63	1.68	1.27	1.60	1.84
21000	71.06	69.05	65.92	1.55	1.98	2.29	1.44	1.85	2.19
23000	65.46	66.08	67.25	1.61	1.92	2.15	1.59	1.84	2.08
25000	69.71	69.25	69.99	1.36	1.80	1.94	1.35	1.83	2.06
30000	47.70	50.44	55.08	6.66	5.54	4.71	19.19	15.30	8.95
31000	61.60	62.25	64.16	2.68	3.07	3.15	3.59	3.74	3.67
32000	64.57	65.84	63.20	2.46	2.82	2.93	2.42	2.82	3.10
33000	61.95	61.45	59.22	2.12	2.61	2.69	1.98	2.56	2.98
34000	54.76	52.26	49.60	2.19	2.78	3.07	2.46	3.11	3.55
35000	44.39	50.27	56.23	2.75	3.06	3.28	3.12	3.30	3.53
36000	64.95	70.69	66.20	2.01	2.60	2.97	2.01	2.46	2.79
37000	69.75	70.60	74.21	1.89	2.53	2.77	1.56	2.21	2.47
38000	69.44	71.32	69.14	2.59	3.02	3.21	2.05	2.70	3.21
38500	72.84	68.71	72.48	2.91	3.24	3.38	2.48	3.10	3.64
39000	73.55	69.30	67.34	2.78	3.22	3.26	2.78	3.35	3.82
39500	69.40	61.84	56.61	2.63	3.24	3.22	2.66	3.27	3.54
40000	57.91	55.66	53.22	2.49	3.09	3.02	2.44	3.09	3.26
40500	52.04	53.41	55.83	2.23	2.84	2.91	2.28	2.83	3.11
41000	55.46	56.64	55.69	1.92	2.53	2.86	2.07	2.58	3.07
42000	54.43	52.85	51.04	1.86	2.61	3.54	1.86	2.48	3.16
43000	48.74	53.15	57.57	2.85	3.58	3.83	2.25	2.99	3.36

Typical Performance Data

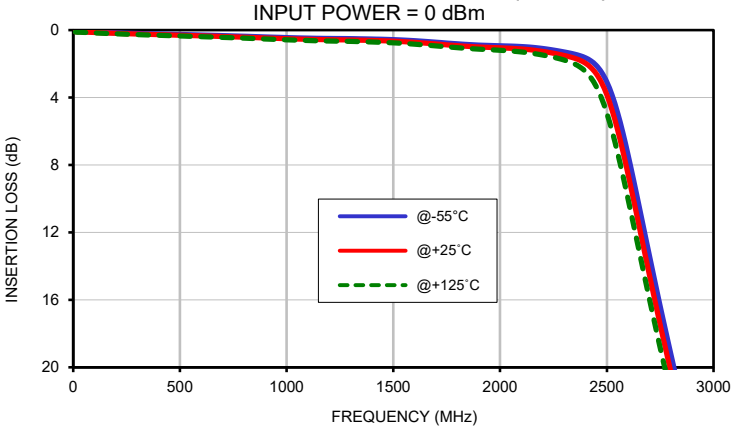
FREQ.	GROUP DELAY		
	(nsec)		
(MHz)	@-55°C	@+25°C	@+125°C
10	0.70	0.71	0.71
20	0.70	0.71	0.71
30	0.70	0.71	0.71
40	0.70	0.71	0.71
50	0.70	0.70	0.71
100	0.69	0.70	0.71
200	0.69	0.69	0.70
220	0.69	0.69	0.70
240	0.69	0.69	0.70
260	0.69	0.69	0.70
280	0.69	0.69	0.70
300	0.69	0.69	0.70
320	0.69	0.69	0.70
340	0.69	0.69	0.70
360	0.69	0.69	0.70
380	0.69	0.69	0.70
400	0.69	0.69	0.70
440	0.69	0.69	0.70
460	0.69	0.69	0.70
480	0.69	0.69	0.70
500	0.69	0.70	0.70
540	0.69	0.70	0.70
580	0.69	0.70	0.70
600	0.70	0.70	0.70
700	0.70	0.70	0.71
800	0.71	0.71	0.71
900	0.71	0.71	0.72
1000	0.72	0.72	0.73
1200	0.74	0.74	0.75
1400	0.77	0.78	0.78
1600	0.81	0.82	0.82
1800	0.85	0.86	0.87
2000	0.94	0.95	0.97
2100	1.00	1.02	1.04
2200	1.09	1.12	1.15
2250	1.16	1.19	1.22

Typical Performance Curves

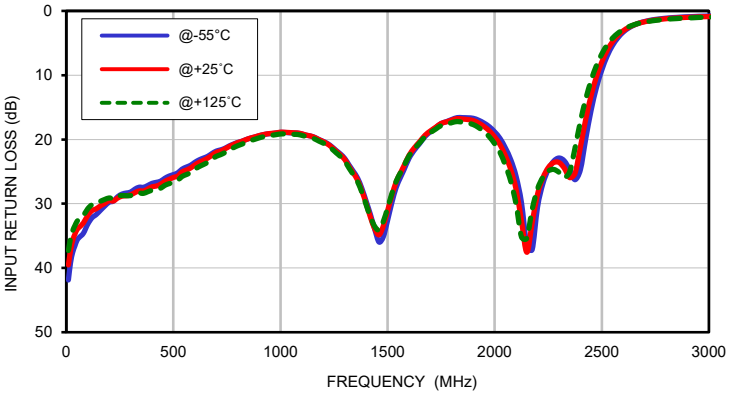
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



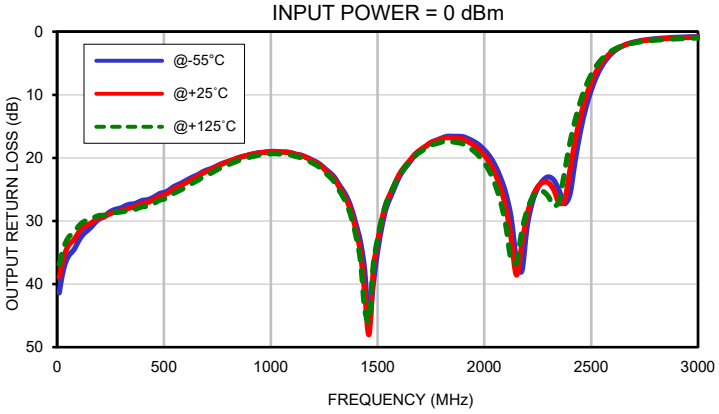
INSERTION LOSS vs. TEMPERATURE (Zoomed)
INPUT POWER = 0 dBm



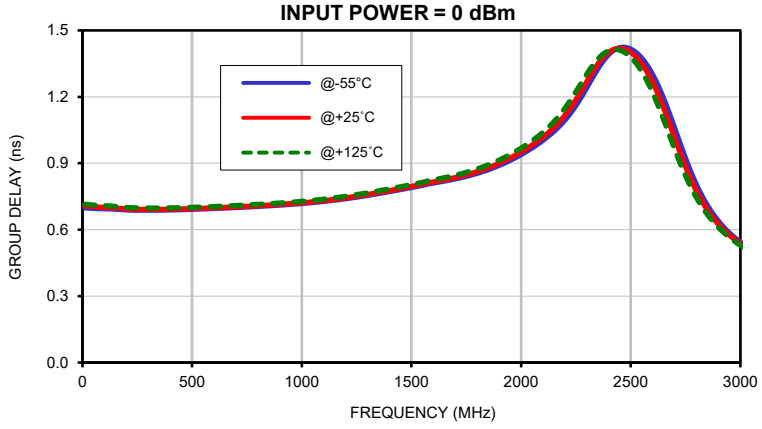
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm

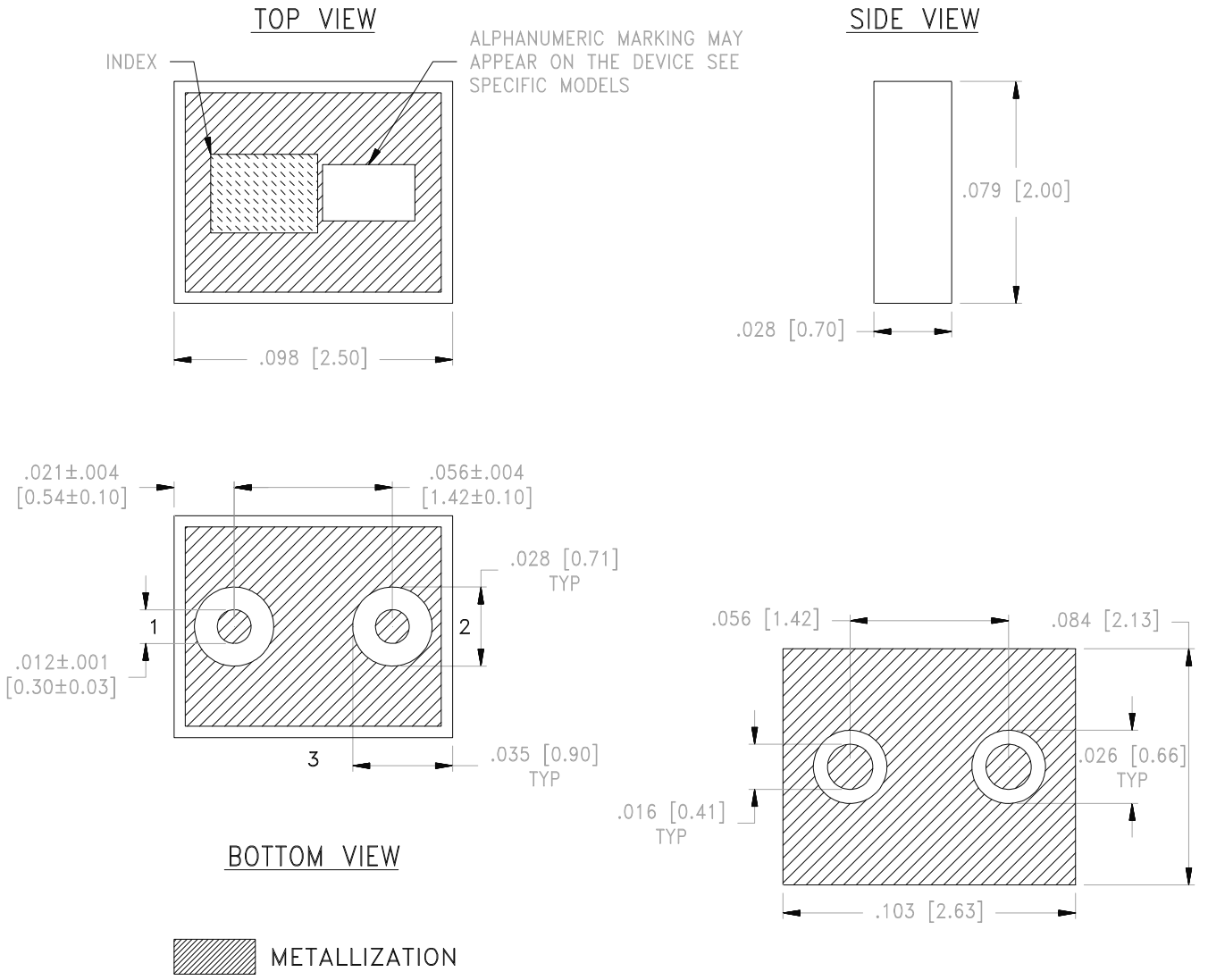


GROUP DELAY vs. TEMPERATURE
INPUT POWER = 0 dBm



Case Style NL

Outline Dimensions NL1008C-9



Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

Notes:

1. Open style, Ceramic base.
2. Termination finish: **as shown below or indicated on Data sheet.**
   For RoHS Case Styles: Gold plate over nickel plate. All models, (+) suffix.
3. Weight: .019 grams.
4. Pad tolerance is non-cumulative.

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Tape & Reel Packaging TR-F75

DEVICE ORIENTATION IN T&R

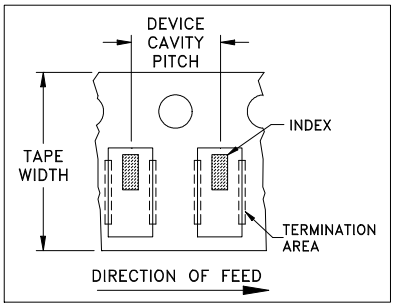


ILLUSTRATION 1

Applicable Case Styles
FV1206-1
FV1206-3

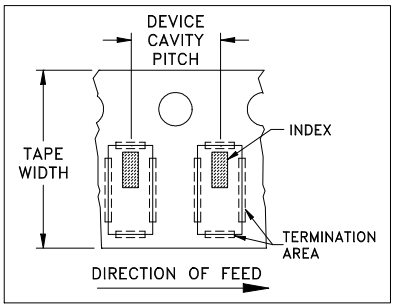


ILLUSTRATION 2

Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9

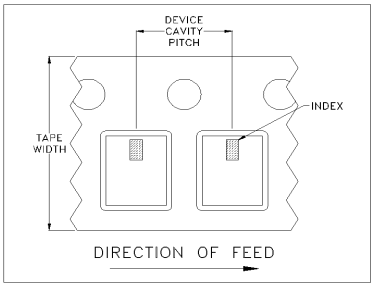


ILLUSTRATION 3

Applicable Case Styles
FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

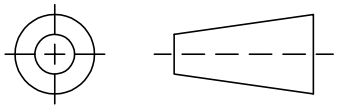
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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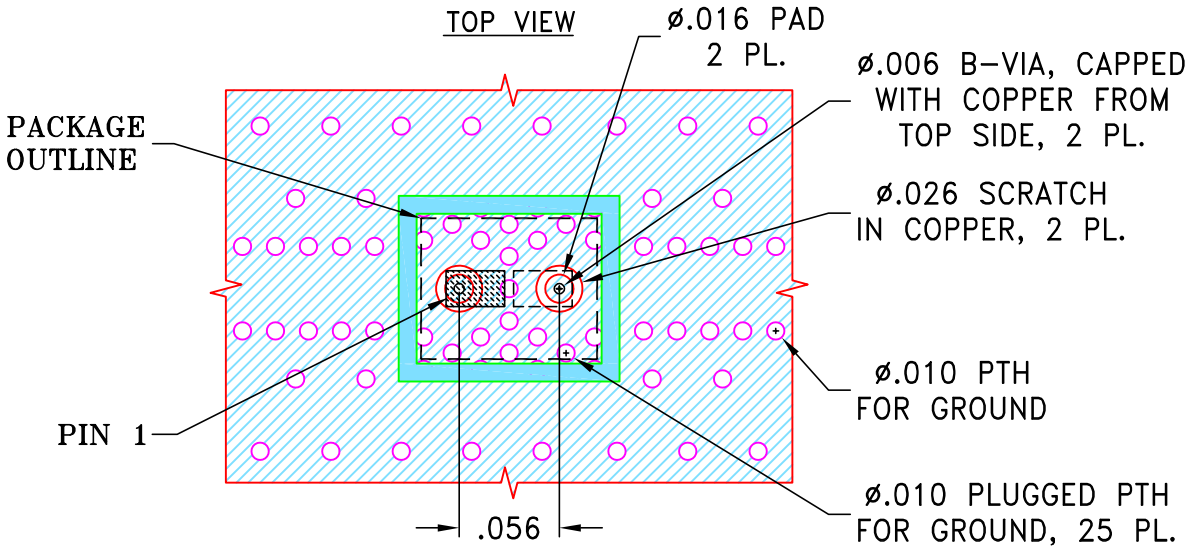
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THIRD ANGLE PROJECTION

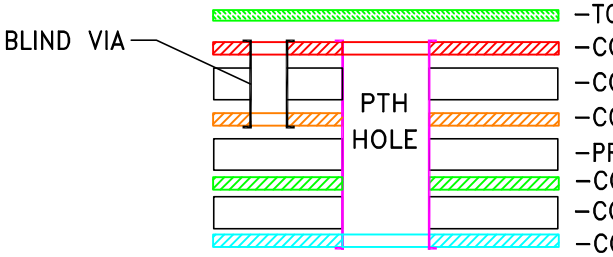


REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-023057	NEW RELEASE	SEP 24	AGS	GT
OR1	NPO-004738	ADDED NL1008C-10 CASE STYLE	OCT 24	AGS	GT
OR2	ECO-023820	NOTES & TOLERANCES UPDATED	NOV 24	AGS	GT

SUGGESTED MOUNTING CONFIGURATION FOR NL1008C-9,NL1008C-10 CASE STYLE



STACK-UP DIAGRAM



-TOP-SOLDERMASK.
-COPPER LAYER 1, .5 OZ. + PLATING
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 2, .5 OZ. + PLATING.
-PREPREG, .0041 MEGTRON 6 R-5670(G)
-COPPER LAYER 3, .5 OZ.
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 4, .5 OZ. + PLATING

1. TOTAL FINISHED THICKNESS 0.0228±.004
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. L4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. DIMENSIONS ARE IN INCHES ; [CD] DENOTES CRITICAL DIMENSIONS.
2. PCB IS MULTILAYER, SEE STACK-UP DIAGRAM AND SHEET-2 FOR ILLUSTRATION.
3. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON 6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING.
   FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
4. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AGS	14 SEP 24
TOLERANCES ON:	CHECKED	MD	16 SEP 24
2 PL DECIMALS ±	APPROVED	GTP	17 SEP 24
3 PL DECIMALS ± .002			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

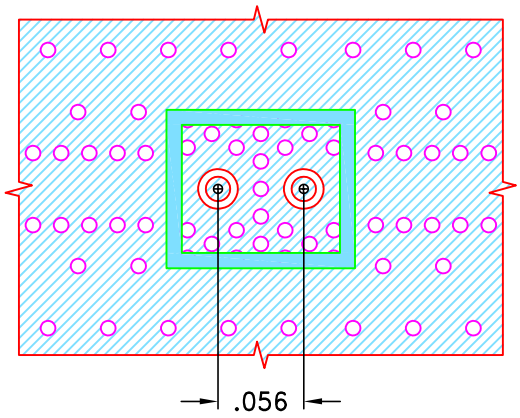
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13 Neptune Avenue
Brooklyn NY 11235

PL, NL1008C-9/10, TB-LFHK-XXXX+

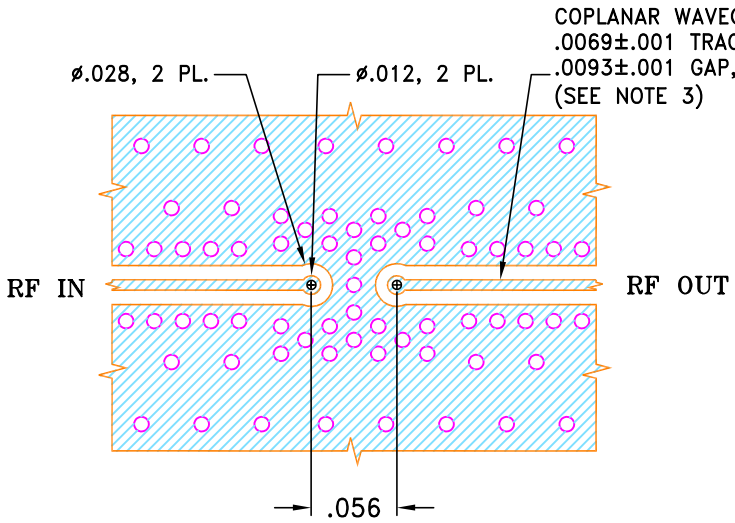
SIZE	CODE IDENT	DRAWING NO:	REV:
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FILE:	SCALE:	SHEET:
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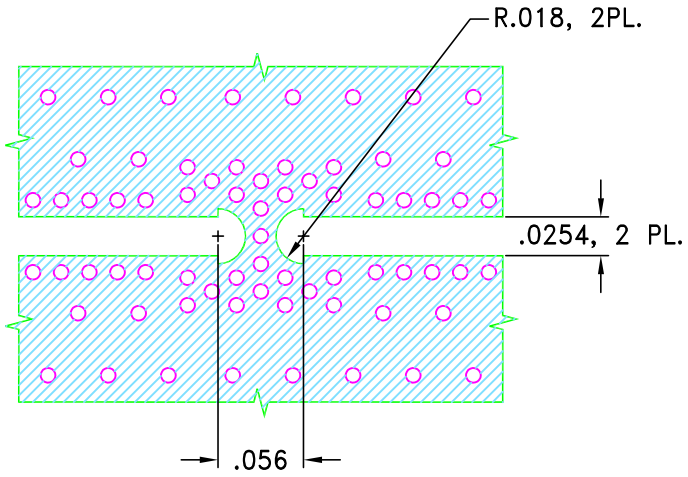
LAYER 1, SOLDER MASK & PTH



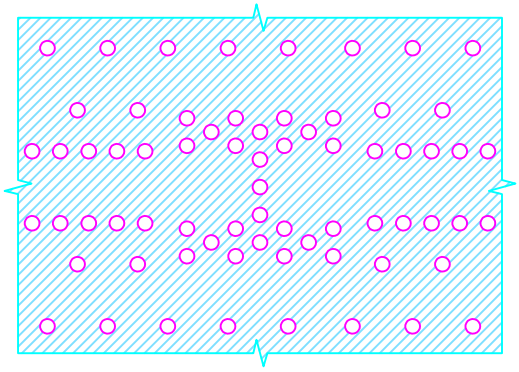
LAYER 2, B-VIA & PTH



LAYER 3 & PTH



LAYER 4 & PTH



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ASHEETA2.DWG REV:A DATE: 01/12/94

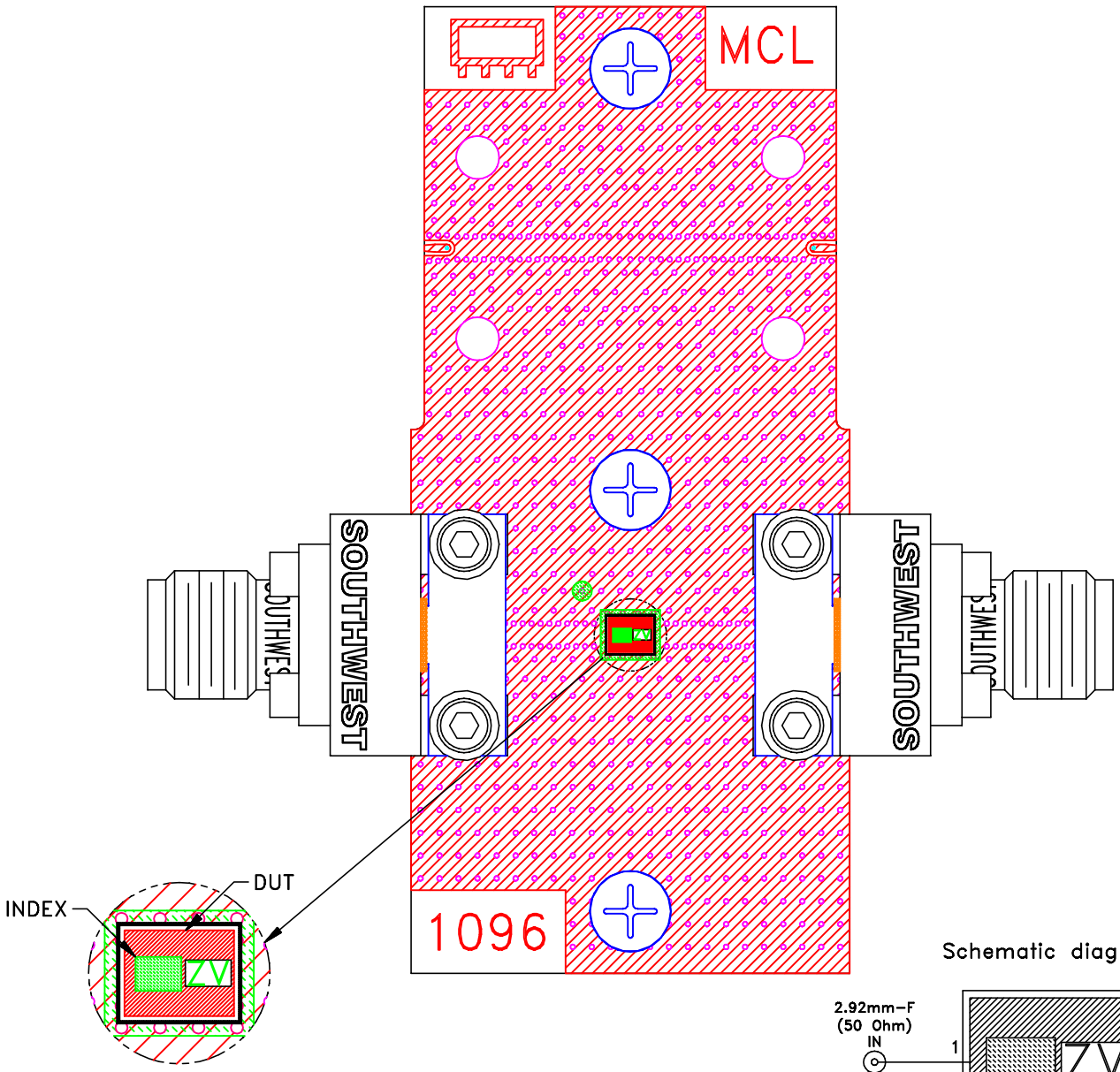
ALL DIMENSIONS ARE IN INCHES EXCEPT OTHERWISE SPECIFIED

SIZE	CODE IDENT	DRAWING NO:	REV:
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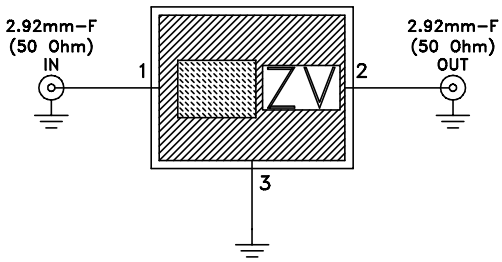
FILE:	SCALE:	SHEET:
98-PL-798	7.7:1	2 OF 2

Evaluation Board and Circuit

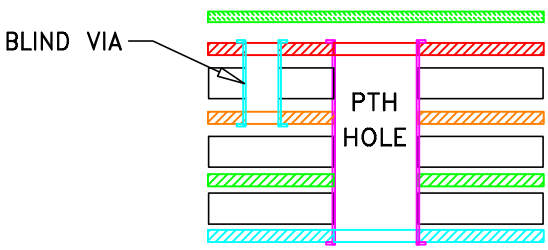
TB-LFHK-2250+



Schematic diagram



STACK-UP DIAGRAM



-TOP-SOLDERMASK.
-COPPER LAYER 1, .5 OZ. + PLATING
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
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-PREPREG, .0041 MEGTRON 6 R-5670(G)
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-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 4, .5 OZ. + PLATING

Notes:

1. PCB Material: MEGTRON-6 R5775(G) OR Equivalent, Dielectric Constant=3.6
2. Total finished thickness: .023
3. 50 Ohm 2.92mm Female End Launch Connector.

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Environmental Specifications ENV06T10

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Test B,B1, 95% Coverage
Thermal Shock	-55° to +125°C, 15 min dwell,250 cycles	MIL-STD-202, Method 107
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	--
High Temp Storage	125°C to 1000 Hrs	---

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